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Datasheet of CCBT16245IDGGRQ1 - IC SWITCH BUS 16BIT FET 48-TSSOP Contact us: sales@integrated-circuit.com Website: www.integrated-circuit.com

SN74CBT16245-Q1 16-BIT FET BUS SWITCH

SCDS170A - JULY 2004 - REVISED JANUARY 2008

| Qualified for Automotive Applications | DGG OR DL PACKAGE | | | | |
|--|--------------------------------------|--|--|--|--|
| Member of Texas Instruments Widebus™ Family | (TOP VIEW) NC 1 48 10E | | | | |
| Standard '16245-Type Pinout | 1B1 2 47 11A1 | | | | |
| 5-Ω Switch Connection Between Two Ports | 1B2 3 46 1A2 | | | | |
| TTL-Compatible Input Levels | GND [4 45] GND | | | | |
| Latch-Up Performance Exceeds 100 mA Per | 1B3 🛮 5 44 🗓 1A3 | | | | |
| JESD 78, Class II | 1B4 🛮 6 43 🗓 1A4 | | | | |
| ESD Protection Exceeds JESD 22 | V _{CC} 7 42 V _{CC} | | | | |
| - 2000-V Human-Body Model (A114-A) | 1B5 8 41 1A5 | | | | |
| - 200-V Machine Model (A115-A) | 1B6 9 40 1A6 GND 10 39 GND | | | | |
| - 1000-V Charged-Device Model (C101) | 1B7 11 38 1 1A7 | | | | |
| | 1B8 12 37 1A8 | | | | |
| description/ordering information | 2B1 13 36 2A1 | | | | |
| The SN74CBT16245 device provides 16 bits of | 2B2 🛮 14 35 🗓 2A2 | | | | |
| high-speed TTL-compatible bus switching in a | GND [15 34] GND | | | | |
| standard '16245 device pinout. The low on-state | 2B3 🛮 16 33 🗓 2A3 | | | | |

standard '16245 device pinout. The low on-state resistance of the switch allows connections to be made with minimal propagation delay.

The device is organized as two 8-bit low-impedance switches with separate output-enable (OE) inputs. When OE is low, the switch is on, and data can flow

The device is organized as two 8-bit low-impedance switches with separate output-enable (\overline{OE}) inputs. When \overline{OE} is low, the switch is on, and data can flow from the A port to the B port, or vice versa. When \overline{OE} is high, the switch is open, and the high-impedance state exists between the two ports.

2B4 [] 17 32 2A4 31 🛮 V_{CC} V_{CC} 2B5 **1** 19 30 1 2A5 29 🛮 2A6 2B6 [] 20 28 GND GND **1** 21 2B7 [27 2A7 22 26 2A8 2B8 [] 23 24 25 2OE NC [

NC - No internal connection

ORDERING INFORMATION[†]

| TA | PACKAGE [‡] | | ORDERABLE PART NUMBER | TOP-SIDE MARKING | |
|---------------|----------------------|---------------|--------------------------|---------------------|--|
| 4000 1 0500 | SSOP - DL | Tape and reel | SN74CBT16245IDLRQ1§ | CBT16245I | |
| -40°C to 85°C | TSSOP - DGG | Tape and reel | CCBT16245IDGGRQ1 | CBT16245I | |

[†] For the most current package and ordering information, see the Package Option Addendum at the end of this document, or see the TI web site at www.ti.com.



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[‡] Package drawings, thermal data, and symbolization are available at www.ti.com/packaging.

[§] Product Preview

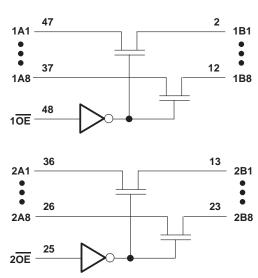
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FUNCTION TABLE (each 8-bit bus switch)

| INPUT OE | FUNCTION |
|-------------|-----------------|
| L | A port = B port |
| Н | Disconnect |

logic diagram (positive logic)



absolute maximum ratings over operating free-air temperature range (unless otherwise noted)†

| Supply voltage range, V_{CC} 0.5 V to 7 V Input voltage range, V_{I} (see Note 1)0.5 V to 7 V |
|---|
| |
| Continuous channel current |
| Input clamp current, I_{IK} ($V_{I/O}$ < 0) |
| Package thermal impedance, θ_{JA} (see Note 2): DGG package |
| DL package |
| Storage temperature range, T _{stg} –65°C to 150°C |

[†] Stresses beyond those listed under "absolute maximum ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under "recommended operating conditions" is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

NOTES: 1. The input and output negative-voltage ratings may be exceeded if the input and output clamp-current ratings are observed.

recommended operating conditions (see Note 3)

| | | MIN | MAX | UNIT |
|-----|----------------------------------|-----|-----|------|
| VCC | Supply voltage | 4 | 5.5 | V |
| VIH | High-level control input voltage | 2 | | V |
| VIL | Low-level control input voltage | | 8.0 | V |
| TA | Operating free-air temperature | -40 | 85 | °C |

NOTE 3: All unused control inputs of the device must be held at V_{CC} or GND to ensure proper device operation. Refer to the TI application report, Implications of Slow or Floating CMOS Inputs, literature number SCBA004.



^{2.} The package thermal impedance is calculated in accordance with JESD 51-7.



SN74CBT16245-Q1 **16-BIT FET BUS SWITCH**

electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

| PAF | RAMETER | | MIN | TYP [†] | MAX | UNIT | | |
|----------------------|----------------|--|------------------------------|--|-----|------|------|----|
| VIK | | $V_{CC} = 4.5 \text{ V},$ | I _I = -18 mA | | | | -1.2 | V |
| | | $V_{CC} = 0$, | V _I = 5.5 V | | | | 10 | |
| II | | $V_{CC} = 5.5 \text{ V},$ | $V_I = 5.5 \text{ V or GND}$ | | | | ±1 | μΑ |
| Icc | | $V_{CC} = 5.5 \text{ V},$ | I _O = 0, | $V_I = V_{CC}$ or GND | | | 3 | μΑ |
| ∆l _{CC} ‡ | Control inputs | $V_{CC} = 5.5 V$, | One input at 3.4 V, | Other inputs at V _{CC} or GND | | | 2.5 | mA |
| Ci | Control inputs | V _I = 3 V or 0 | | | | 3.5 | | pF |
| C _{io(OFF)} |) | $V_0 = 3 \text{ V or } 0,$ | OE = V _{CC} | | | 4.5 | | pF |
| | | $V_{CC} = 4 \text{ V},$ TYP at $V_{CC} = 4 \text{ V}$ | V _I = 2.4 V, | I _I = 15 mA | | 14 | 20 | |
| ron§ | | | V 0 | I _I = 64 mA | | 5 | 7 | Ω |
| | | V _{CC} = 4.5 V | V _I = 0 | $I_I = 30 \text{ mA}$ | | 5 | 7 | |
| | | | V _I = 2.4 V, | I _I = 15 mA | | 8 | 12 | |

[†] All typical values are at $V_{CC} = 5 \text{ V}$ (unless otherwise noted), $T_A = 25^{\circ}\text{C}$.

switching characteristics over recommended operating free-air temperature range (unless otherwise noted) (see Figure 1)

| PARAMETER | FROM | TO | V _{CC} = 4 V | V _{CC} = 5 V ± 0.5 V | | UNIT |
|------------------|---------|----------|-----------------------|----------------------------------|------|------|
| | (INPUT) | (OUTPUT) | MIN MAX | MIN | MAX | |
| $t_{pd}\P$ | A or B | B or A | 0.35 | | 0.25 | ns |
| ^t en | ŌĒ | A or B | 6.1 | 1.2 | 5.6 | ns |
| ^t dis | ŌĒ | A or B | 7.5 | 3.9 | 7.7 | ns |

The propagation delay is the calculated RC time constant of the typical on-state resistance of the switch and the specified load capacitance, when driven by an ideal voltage source (zero output impedance).



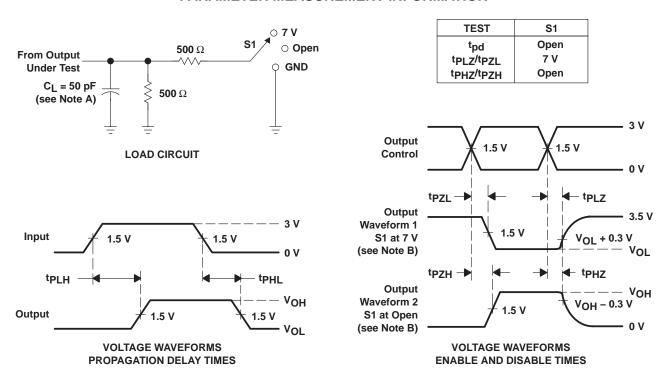
[‡]This is the increase in supply current for each input that is at the specified TTL voltage level, rather than V_{CC} or GND.

[§] Measured by the voltage drop between the A and B terminals at the indicated current through the switch. On-state resistance is determined by the lower of the voltages of the two (A or B) terminals.



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PARAMETER MEASUREMENT INFORMATION



NOTES: A. C_I includes probe and jig capacitance.

- B. Waveform 1 is for an output with internal conditions such that the output is low, except when disabled by the output control. Waveform 2 is for an output with internal conditions such that the output is high, except when disabled by the output control.
- C. All input pulses are supplied by generators having the following characteristics: PRR \leq 10 MHz, Z_O = 50 Ω , $t_f \leq$ 2.5 ns. $t_f \leq$ 2.5 ns.
- D. The outputs are measured one at a time, with one transition per measurement.
- E. tpLZ and tpHZ are the same as tdis.
- F. tpzL and tpzH are the same as ten.
- G. t_{PLH} and t_{PHL} are the same as t_{pd} .

Figure 1. Load Circuit and Voltage Waveforms





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PACKAGE OPTION ADDENDUM

18-Sep-2008

PACKAGING INFORMATION

| Orderable Device | Status ⁽¹⁾ | Package Type | Package Drawing | Pins | Package Qty | Eco Plan ⁽²⁾ | Lead/Ball Finish | MSL Peak Temp ⁽³⁾ |
|------------------|-----------------------|-----------------|--------------------|------|----------------|-------------------------|------------------|------------------------------|
| CCBT16245IDGGRQ1 | ACTIVE | TSSOP | DGG | 48 | 2000 | Pb-Free (RoHS) | CU NIPDAU | Level-1-250C-UNLIM |

(1) The marketing status values are defined as follows:

ACTIVE: Product device recommended for new designs.

LIFEBUY: TI has announced that the device will be discontinued, and a lifetime-buy period is in effect.

NRND: Not recommended for new designs. Device is in production to support existing customers, but TI does not recommend using this part in a new design.

PREVIEW: Device has been announced but is not in production. Samples may or may not be available.

OBSOLETE: TI has discontinued the production of the device.

(2) Eco Plan - The planned eco-friendly classification: Pb-Free (RoHS), Pb-Free (RoHS Exempt), or Green (RoHS & no Sb/Br) - please check http://www.ti.com/productcontent for the latest availability information and additional product content details.

TBD: The Pb-Free/Green conversion plan has not been defined.

Pb-Free (RoHS): TI's terms "Lead-Free" or "Pb-Free" mean semiconductor products that are compatible with the current RoHS requirements for all 6 substances, including the requirement that lead not exceed 0.1% by weight in homogeneous materials. Where designed to be soldered at high temperatures, TI Pb-Free products are suitable for use in specified lead-free processes.

Pb-Free (RoHS Exempt): This component has a RoHS exemption for either 1) lead-based flip-chip solder bumps used between the die and package, or 2) lead-based die adhesive used between the die and leadframe. The component is otherwise considered Pb-Free (RoHS compatible) as defined above.

Green (RoHS & no Sb/Br): TI defines "Green" to mean Pb-Free (RoHS compatible), and free of Bromine (Br) and Antimony (Sb) based flame retardants (Br or Sb do not exceed 0.1% by weight in homogeneous material)

(3) MSL, Peak Temp. -- The Moisture Sensitivity Level rating according to the JEDEC industry standard classifications, and peak solder temperature.

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NOTE: Qualified Version Definitions:

• Catalog - TI's standard catalog product



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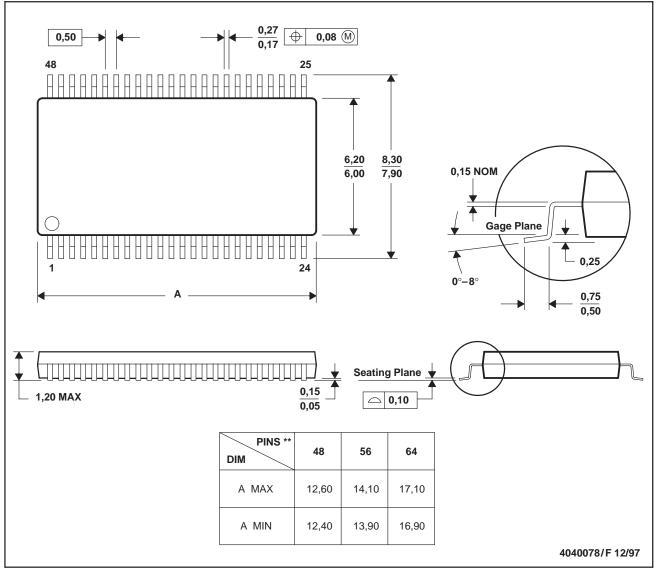
MECHANICAL DATA

MTSS003D - JANUARY 1995 - REVISED JANUARY 1998

DGG (R-PDSO-G**)

48 PINS SHOWN

PLASTIC SMALL-OUTLINE PACKAGE



NOTES: A. All linear dimensions are in millimeters.

B. This drawing is subject to change without notice.

C. Body dimensions do not include mold protrusion not to exceed 0,15.

D. Falls within JEDEC MO-153





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